REV LETTER: F PAGE NO: 1 OF 1 PART NUMBER:

Polymer PTC Devices

Surface mount fuses

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Features

LP-ISM110

- □ Small size of 0805
- □ Lead-free and compliant with the European Union RoHS Directive 2002/95/EC
- ☐ Fast tripping resettable circuit protection
- □ Surface mount packaging for automated assembly
- □ Agency Recognition: UL pending





Product Dimensions (mm)

Dort number	Α	В	С	D	E	- Part marking	
Part number	Max.	Max.	Max.	Min.	Min.		
LP-ISM110	2.20	1.50	1.80	0.10	0.20	6	



Top View

Side View

Electrical Characteristics

Part number	Ι _Η	Ι _Τ	V_{max}	I _{max}	T _{trip}		Pd _{typ}	R_{min}	R _{1max}
Part number -	(A)	(A)	(V)	(A)	Current(A)	Time(S)	(W)	(Ω)	(Ω)
LP-ISM110	1.10	2.20	6.00	40.0	8.00	0.30	0.5	0.05	0.21

I_H=Hold current: maximum current at which the device will not trip at 25°C still air.

I_T=Trip current: minimum current at which the device will always trip at 25℃ still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

I_{max}=Maximum fault current device can withstand without damage at rated voltage.

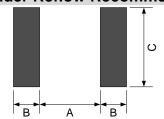
T_{trip}=Maximum time to trip(s) at assigned current.

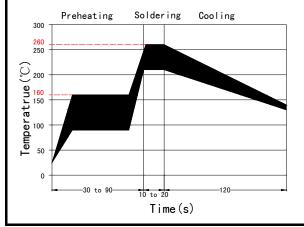
Pd_{tvo}=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

R_{min}=Minimum device resistance at 25°C prior to tripping.

 $R_{1\text{max}}\!\!=\!\!\text{Maximum}$ device resistance measured in the nontripped state 1 hour post reflow.

Solder Reflow Recommendations





Solder Pad Layouts Part number A B

Part number	Α	В	С	
	(mm)	(mm)	(mm)	
LP-ISM110	1.20	1.00	1.50	

- * Recommended reflow methods: IR, Vapor phase, hot air oven.
- * Devices can be cleaned using standard industry methods and solvents.

Notes:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.
- Devices are not designed to be wave soldered to the bottom side of the board.

Package Information

Tape & Reel: 4000pcs per reel.

Effectivity: Reference documents shall be the issue in effect on the date of invitation for bid.

Caution: Operation beyond the rated voltage or current may result in rupture electrical arcing or flame.